

# MOS INTEGRATED CIRCUIT $\mu$ PD4715A

#### RS-232 LINE DRIVER/RECEIVER

The  $\mu$ PD4715A is a high-voltage silicon gate CMOS line driver/reciever conforming to the EIA/TIA-232-E standard. It can operate with a single +5 V power source because it is provided with a DC-DC converter. In addition, this line driver/receiver has many ancillary functions, including output control, threshold select, and standby functions. Because the  $\mu$ PD4715A is provided with five output driver circuits and three receiver circuits, it can constitute an RS-232 interface circuit with a single chip.

#### **FEATURES**

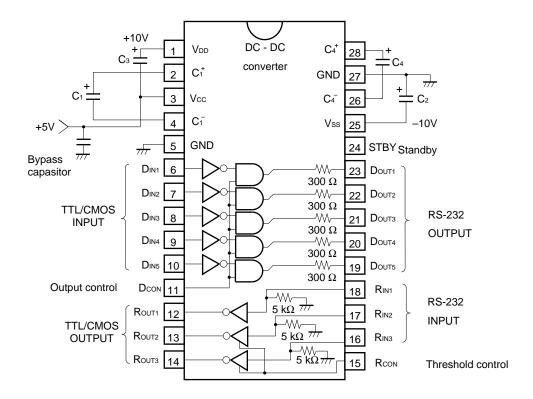
- Conforms to EIA/TIA-232-E (RS-232C) standard
- +5 V single power source
- Threshold select pin selecting two types of threshold voltages
- Standby mode can be set by making standby pin high to reduce circuit current.
- Three-state output configuration. Both driver and receiver outputs go into high-impedance state in standby mode.

#### ORDERING INFORMATION

| Part Number | Package                      |  |
|-------------|------------------------------|--|
| μPD4715ACY  | 28-pin plastic DIP (400 mil) |  |
| μPD4715AGT  | 28-pin plastic SOP (375 mil) |  |



## **BLOCK DIAGRAM/PIN CONFIGURATION (Top View)**



- \* V<sub>DD</sub> and V<sub>ss</sub> are output pins of voltages internally boosted. Connecting a load directly to these pins is not recommended.
- \*\* The standby pin is internally pulled down.
- \*\*\* Use capacitors with a working voltage of 16 V or higher as C<sub>1</sub> through C<sub>4</sub>. Insert a bypass capasitor about 0.1 to 1 μF between Vcc pin to GND pin.



## TRUTH TABLE

## **Drivers**

| STBY | Dcon | Din | <b>D</b> оит | Remark                               |
|------|------|-----|--------------|--------------------------------------|
| Н    | Х    | Х   | Z            | Standby mode (DC-DC converter stops) |
| L    | L    | Х   | L            | Mark level output                    |
| L    | Н    | L   | Н            | Space level output                   |
| L    | Н    | Н   | L            | Mark level output                    |

## Receivers

| STBY | Rın | Rоит | Remark                              |
|------|-----|------|-------------------------------------|
| Н    | Х   | Z    | Stanby mode (DC-DC converter stops) |
| L    | L   | Н    | Mark level input                    |
| L    | Н   | L    | Space level input                   |

# Receiver input threshold voltage

| Rcon | R <sub>IN1</sub> | RIN2 to RIN3 |
|------|------------------|--------------|
| L    | A mode           | A mode       |
| Н    | A mode           | B mode       |

H: high level, L: low level, Z: high impedance, X: H or L



# ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

| Parameter                   | Symbol           | Ratings              | Unit |
|-----------------------------|------------------|----------------------|------|
| Supply voltage              | Vcc              | -0.5 to +6.0         | V    |
| Driver input voltage        | Din              | −0.5 to Vcc +0.5     | V    |
| Receiver input voltage      | Rin              | -30.0 to +30.0       | V    |
| Driver output voltage       | <b>D</b> оит     | -25.0 to +25.0 Note1 | V    |
| Receiver output voltage     | Rout             | -0.5 to Vcc + 0.5    | V    |
| Receiver input current      | lin              | ±60.0                | mA   |
| Operating temperature range | TA               | -40 to +85           | °C   |
| Storage temperature range   | T <sub>stg</sub> | -55 to +150          | °C   |
| Power dissipation           | PT               | 0.5                  | W    |

Note 1. Pulse width: 1 ms, duty factor: 10% MAX.

#### RECOMMENDED OPERATING RANGE

| Parameter                   | Symbol | MIN. | TYP. | MAX. | Unit |
|-----------------------------|--------|------|------|------|------|
| Supply voltage              | Vcc    | 4.5  | 5.0  | 5.5  | V    |
| Receiver input voltage      | Rın    | -25  |      | +25  | V    |
| Operating temperature range | TA     | -20  |      | 80   | °C   |
| External capacitance        | Note 2 | 4.7  |      | 47   | μF   |

**Note 2.** The capacitance of an electrolytic capacitor decreases at a low temperature (0  $^{\circ}$ C or lower). Determine the capacitance of the capacitor to be used taking this into consideration when the  $\mu$ PD4715A is used at a low temperature. Keep the wiring length between the capacitor and IC as short as possible.



# ELECTRICAL CHARACTERISTICS (OVERALL) (Unless otherwise specified, $V_{CC}$ = +5 V ±10 %, $T_A$ = -20 °C to +80 °C, $C_1$ to $C_4$ = 22 $\mu$ F)

| Parameter               | Symbol    | Conditions   | MIN. | TYP. | MAX. | Unit |
|-------------------------|-----------|--|------|------|------|------|
| Circuit current         |           | Vcc = +5 V, no load, R <sub>IN</sub> pin open  |      |      |      |      |
|                         | Icc1      | (Standby pin open)   |      | 9.0  | 18.0 | mA   |
| Circuit current         |           | $Vcc = +5 \text{ V}, \text{ RL} = 3 \text{ k}\Omega \text{ (Dout)}, \text{ DIN} = \text{GND},$ |      |      |      |      |
|                         | Icc2      | RIN and ROUT pins open   |      | 25.0 | 40.0 | mA   |
|                         |           | (Standby pin open)   |      |      |      |      |
| Standby circuit current | Icc       | Vcc = +5 V, no load, R <sub>IN</sub> pin open  |      |      |      |      |
|                         | (Standby) | (Standby pin high)   |      | 50   | 120  | μΑ   |
| Standby low-level       | VIL       | Note 3   |      |      |      |      |
| input voltage           | (Standby) |  |      |      | 0.8  | V    |
| Standby high-level      | ViH       |  |      |      |      |      |
| input voltage           | (Standby) |  | 2.0  |      |      | V    |
| Standby high-level      | Іін       | Vcc = +5.5 V   |      |      |      | _    |
| input current           | (Standby) | V <sub>1</sub> = 5.5 V   |      |      | 100  | μΑ   |
| Standby low-level       | lıL       | Vcc = +5.5 V   |      |      |      | _    |
| input current           | (Standby) | V1 = 0 V   |      |      | _1   | μΑ   |
| Input capacitance       |           | Driver input and receiver input  |      |      | 4.0  |      |
|                         | Cin       | Vcc = +5 V, vs. GND, f = 1 MHz   |      |      | 10   | pF   |

<sup>\*</sup> TYP.: Typical (reference) value at  $T_A = 25$  °C.

**Note 3.** Because the standby pin is internally pulled down, if the standby pin is left open, operating mode is in effect.

# ELECTRICAL CHARACTERISTICS (DRIVER) (Unless otherwise specified, Vcc = +5 V $\pm 10$ %, $T_A$ = -20 °C to +80 °C, $C_1$ to $C_4$ = 22 $\mu$ F)

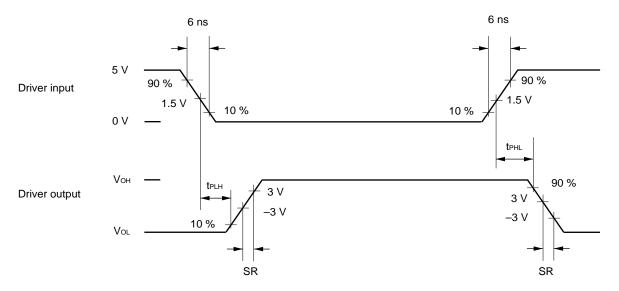
| Parameter                      | Symbol       | Conditions   | MIN. | TYP. | MAX. | Unit |
|--------------------------------|--------------|--|------|------|------|------|
| Low-level input voltage        | VIL          |  |      |      | 0.8  | V    |
| High-level input voltage       | ViH          |  | 2.0  |      |      | V    |
| Low-level input current        | Iı∟          |  | 0    |      | -1.0 | μΑ   |
| High-level input current       | lін          |  | 0    |      | 1.0  | μΑ   |
| Output voltage                 |              | Vcc = +5.0 V, R <sub>L</sub> = ∞, T <sub>A</sub> = 25 °C     |      | ±9.7 |      | V    |
|                                | VDO          | $Vcc = +5.0 \text{ V}, \text{ RL} = 3 \text{ k}\Omega$       | ±5.5 |      |      | V    |
|                                |              | $Vcc = +4.5 \text{ V}, \text{ R}_L = 3 \text{ k}Ω,$          | ±5.0 |      |      | V    |
| Output short current           | Isc          | Vcc = +5.0 V, vs. GND  |      | ±15  | ±40  | mA   |
| Slew rate                      |              | $C_L = 10 \text{ pF}, R_L = 3 \text{ to } 7 \text{ k}\Omega$ | 1.5  | 9    | 30   | V/μs |
|                                | SR           | $C_L$ = 2500 pF, $R_L$ = 3 to 7 k $\Omega$                   | 1.5  | 5    | 30   | V/μs |
| Propagation delay time Note 4  | <b>t</b> PHL |  |      |      |      |      |
|                                | tplH         | $R_L = 3.5 \text{ k}\Omega$ , $C_L = 2500 \text{ pF}$        |      | 0.8  |      | μs   |
| Output resistance              |              | Vcc = Vdd = Vss = 0 V  |      |      |      |      |
|                                | Ro           | Vout = ±2 V  | 300  |      |      | Ω    |
| Standby output transition time | tDAZ         | Note 5   |      | 4    | 10   | μs   |
| Standby output transition time | <b>t</b> dza | Note 5   |      | 25   | 50   | ms   |

<sup>\*</sup> TYP.: Typical (reference) value at  $T_A = 25$  °C.

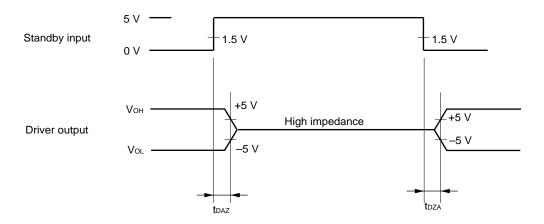


#### Note 4. Test point

If the output control pin is made low, the driver output goes low regardless of the driver input state.



#### Note 5. Test Point



Do not perform communication within the standby output transition time toza on power application or on releasing the standby mode.



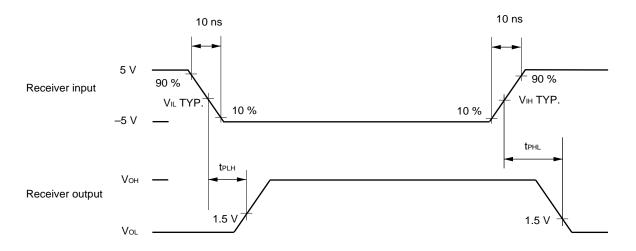
# ELECTRICAL CHARACTERISTICS (RECEIVER) (Unless otherwise specified, Vcc = +5 V $\pm$ 10 %, T<sub>A</sub> = -20 °C to +80 °C, C<sub>1</sub> to C<sub>4</sub> = 22 $\mu$ F)

| Parameter                      | Symbol       | Conditions                                     | MIN. | TYP. | MAX. | Unit |
|--------------------------------|--------------|--|------|------|------|------|
| Low-level output voltage       | Vol          | Iout = 4 mA                                    |      |      | 0.4  | V    |
| High-level output voltage      | Vон          | Iо∪т = −4 mA                                   | Vcc  |      |      | V    |
|                                |              |  | -0.8 |      |      |      |
| Low-level input voltage        | VIL          | Rcon pin                                       |      |      | 0.8  | V    |
| High-level input voltage       | ViH          | Rcon pin                                       | 2.0  |      |      | V    |
| Propagation delay time Note 7  | <b>t</b> PHL | R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 150 pF |      | 0.13 |      | μs   |
|                                | tplH         |  |      |      |      |      |
| Input current                  | lin          |  |      | 1    |      | mA   |
| Input resistance               | Rı           |  | 3    | 5    | 7    | kΩ   |
| Input pin release voltage      | Vio          | Input threshold A mode only                    |      |      | 0.5  | V    |
| Input threshold A mode         | Vıн          | Vcc = +5 V                                     | 1.6  | 2.2  | 2.6  | V    |
| (Rcon pin low)                 | VIL          | Vcc = +5 V                                     | 0.6  | 1    | 1.6  | V    |
|                                | Vн           | Vcc = +5 V (hysteresis width)                  | 0.5  | 1.2  | 1.8  | V    |
| Input threshold B mode Note 6  | Vıн          | Vcc = +5 V                                     | 1.6  | 2.2  | 2.6  | V    |
| (Rcon pin high)                | VIL          | Vcc = +5 V                                     | -0.4 | -1.8 | -3.0 | V    |
|                                | Vн           | Vcc = +5 V (hysteresis width)                  | 2.6  | 4.0  | 5.4  | V    |
| Standby output transition time | <b>t</b> DAZ | Note 8   |      | 0.4  | 1    | μs   |
| Standby output transition time | <b>t</b> dza | Note 8   |      | 1    | 10   | ms   |

<sup>\*</sup> TYP.: Typical (reference) value at  $T_A = 25$  °C.

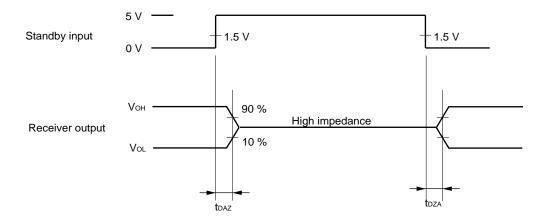
**Note 6.** This data is applicable to receivers 2 and 3 only. Receiver 1 is fixed in A mode.

Note 7. Test Point





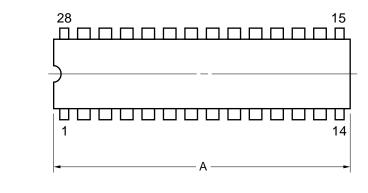
Note 8. Test Point

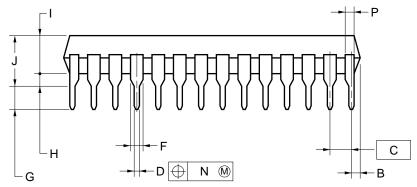


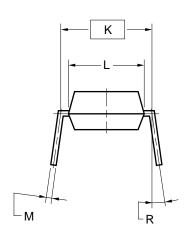
The receiver output is undefined during the standby output transition time  $t_{DZA}$ . Do not perform communication in the standby output transition time  $t_{DZA}$  on power application or on releasing the standby mode.

#### **PACKAGE DRAWINGS**

# 28PIN PLASTIC DIP (400 mil)







#### NOTES

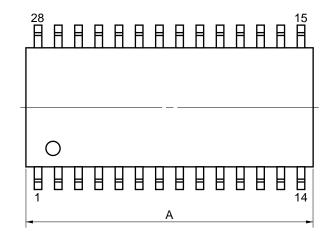
- 1) Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

| ITEM | MILLIMETERS            | INCHES                    |
|------|------------------------|---------------------------|
| Α    | 35.56 MAX.             | 1.400 MAX.                |
| В    | 1.27 MAX.              | 0.050 MAX.                |
| С    | 2.54 (T.P.)            | 0.100 (T.P.)              |
| D    | 0.50±0.10              | $0.020^{+0.004}_{-0.005}$ |
| F    | 1.1 MIN.               | 0.043 MIN.                |
| G    | 3.5±0.3                | 0.138±0.012               |
| Н    | 0.51 MIN.              | 0.020 MIN.                |
| I    | 4.31 MAX.              | 0.170 MAX.                |
| J    | 5.72 MAX.              | 0.226 MAX.                |
| K    | 10.16 (T.P.)           | 0.400 (T.P.)              |
| L    | 8.6                    | 0.339                     |
| М    | $0.25^{+0.10}_{-0.05}$ | $0.010^{+0.004}_{-0.003}$ |
| N    | 0.25                   | 0.01                      |
| Р    | 0.9 MIN.               | 0.035 MIN.                |
| R    | 0~15°                  | 0~15°                     |
|      |                        |                           |

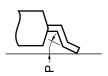
P28C-100-400-1

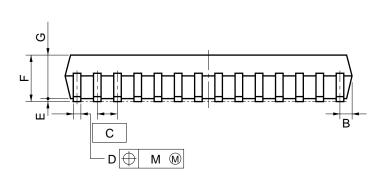


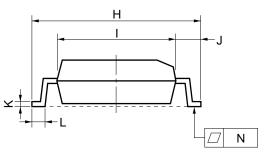
# 28 PIN PLASTIC SOP (375 mil)











#### NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

| ITEM | MILLIMETERS            | INCHES                    |
|------|------------------------|---------------------------|
| Α    | 18.07 MAX.             | 0.712 MAX.                |
| В    | 0.78 MAX.              | 0.031 MAX.                |
| С    | 1.27 (T.P.)            | 0.050 (T.P.)              |
| D    | $0.40^{+0.10}_{-0.05}$ | $0.016^{+0.004}_{-0.003}$ |
| Е    | 0.1±0.1                | 0.004±0.004               |
| F    | 2.9 MAX.               | 0.115 MAX.                |
| G    | 2.50                   | 0.098                     |
| Н    | 10.3±0.3               | $0.406^{+0.012}_{-0.013}$ |
| I    | 7.2                    | 0.283                     |
| J    | 1.6                    | 0.063                     |
| K    | $0.15^{+0.10}_{-0.05}$ | $0.006^{+0.004}_{-0.002}$ |
| L    | 0.8±0.2                | $0.031^{+0.009}_{-0.008}$ |
| М    | 0.12                   | 0.005                     |
| N    | 0.15                   | 0.006                     |
| Р    | 3°+7°                  | 3°+7°                     |

P28GM-50-375B-3



#### RECOMMENDED SOLDERING CONDITIONS

Soldering the  $\mu$ PD4715A under the conditions listed in the table below is recommended.

For soldering methods and conditions other than those recommended, consult NEC.

#### Surface mount type

For the details of the recommended soldering conditions of the surface mount type, refer to Information document "Semiconductor Device Mounting Technology Manual" (C10535EJ7V0IF00)

#### $\mu$ PD4715AGT

| Soldering Method    | Soldering Condition                                       | Recommended Condition Symbol |
|---------------------|---|------------------------------|
| Infrared reflow     | Package peak temperature: 235 °C, Time: 30 seconds MAX.   | IR35-00-2                    |
|                     | (210 °C MIN.), Number of times: 2, Number of days: not    |                              |
|                     | limited*  |                              |
| VPS                 | Package peak temperature: 215 °C, Time: 40 seconds MAX.   | VP15-00-2                    |
|                     | (200 °C MIN.), Number of times: 2, Number of days: not    |                              |
|                     | limited*  |                              |
| Wave soldering      | Soldering bath temperature: 260 °C MAX., Time: 10 seconds | WS60-00-1                    |
|                     | MAX., Number of times : 1, Number of days: not limited*   |                              |
| Pin partial heating | Pin temperature: 300 °C MAX (lead temperature), Time: 3   |                              |
|                     | seconds MAX. (per lead pin), Number of days: not limited* |                              |

<sup>\*</sup> The number of days the device can be stored at 25 °C, 65 % RH MAX. after the dry pack has been opened.

Caution Do not use two or more soldering methods in combination (except the pin partial heating method).

#### Throught-hole type

#### $\mu$ PD4715ACY

| Soldering Method | Soldering Conditions   |
|------------------|--|
| Wave soldering   | Soldering bath temperature: 260 °C MAX., Time: 10 seconds MAX. |

#### REFERENCE DOCUMENTS

"NEC Semiconductor Device Reliability/Quality Control System" (IEI-1212)

"Quality Grade on NEC Semiconductor Devices" (IEI-1209)

"Semiconductor Device Mounting Technology Manual" (C10535EJ7V0IF00)

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Anti-radioactive design is not implemented in this product.